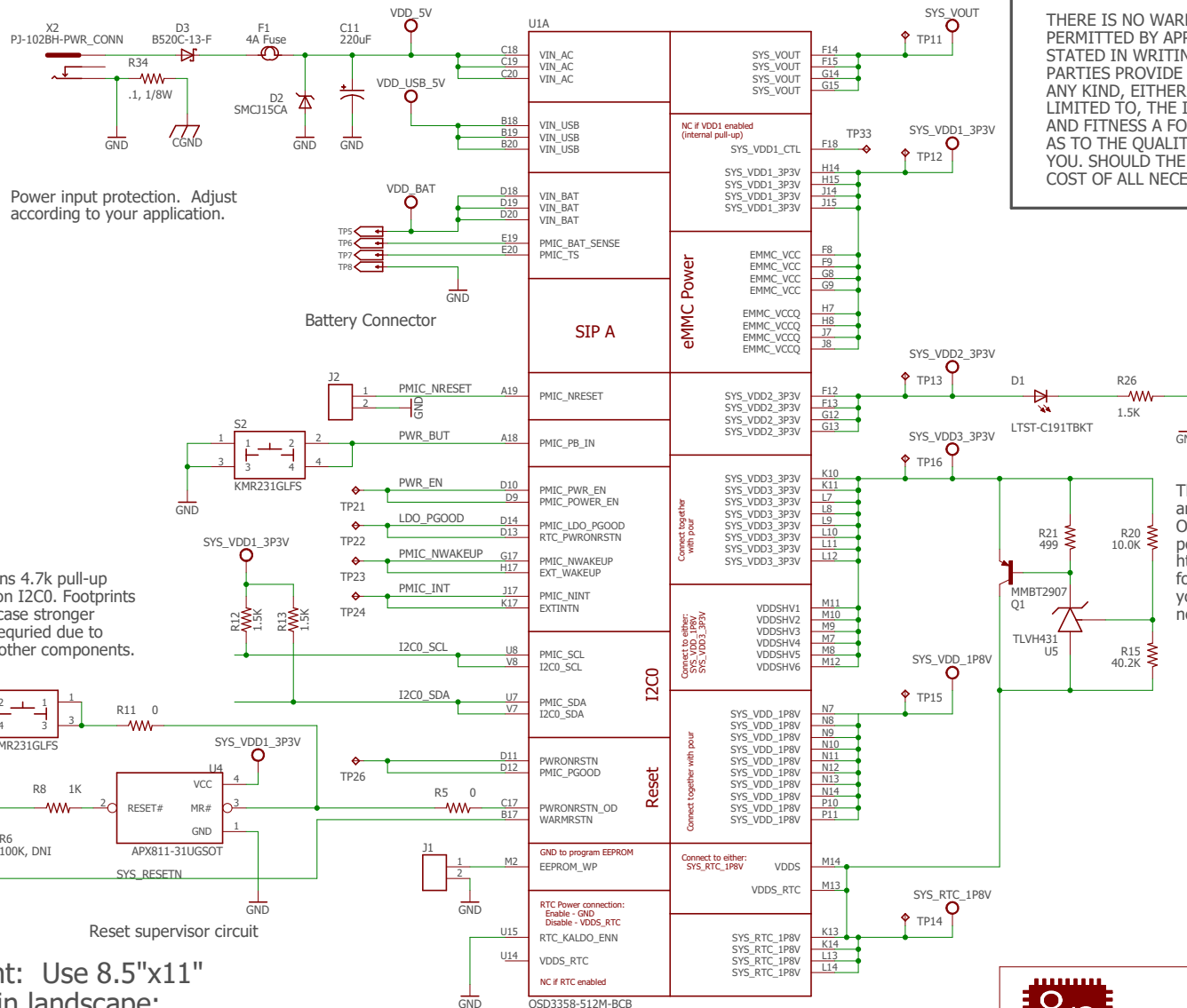


Power & Reset

Octavo Systems OSD335x C-SiP
Reference, Evaluation and Development (RED) Platform

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SiP contains 4.7k pull-up resistors on I2C0. Footprints added in case stronger pull-ups required due to layout or other components.

This is a clamping circuit between the VDD5 and VDDSHV inputs of the AM335x inside the OSD335x-SM. The clamping circuit is related to power down issues (see <https://octavosystems.com/osd335x/clamping/> for more information). This may not be needed in your application if the power down conditions do not apply to your application.

Reset inputs:

- 1) Manual push-button
- 2) PMIC_PGOOD

Reset supervisor MR# has internal pull up to SYS_VDD1_3P3V. Each reset input is effectively open drain and can only pull reset line low. Resistors added only for debug and are not necessary.

To Print: Use 8.5"x11" paper in landscape; 0.69 scaling factor.



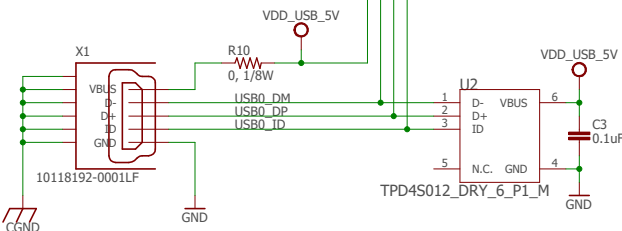
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Clocks, Analog & USB

Clock resistor R24 may not be needed in your design.
See <https://octavosystems.com/osd335x/clock/> for more information.

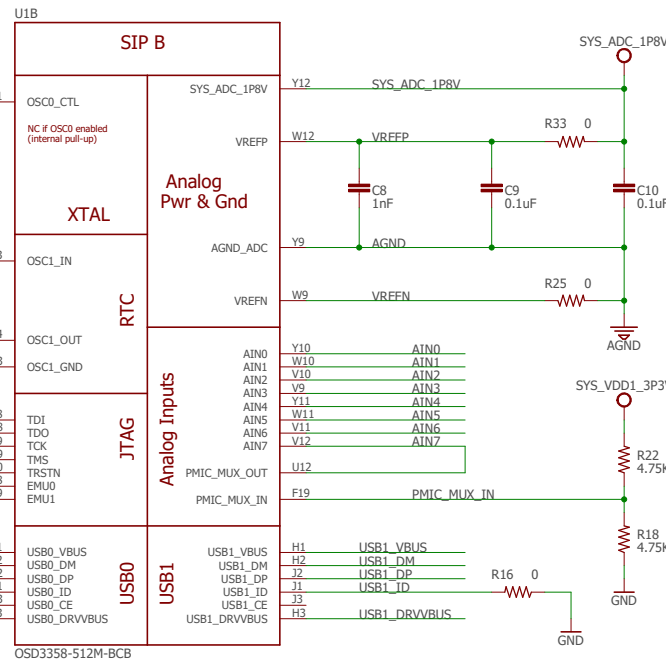
32kHz Oscillator is used for RTC. If your application does not use the RTC, then this can be removed.

The 0 Ohm resistor (R10) on the VBUS input can be replaced with a ferrite bead for noise suppression or a solder bridge for cost reduction.



USB Client

Per the TPD4S012 datasheet, D-, D+ and ID have the same ESD circuitry. Therefore, to ease routing, D- and D+ have been swapped from the default mapping.



If the analog interface is not used, then VREFP and VREFN should be shorted to AGND.

SYS_ADC_1P8V and AGND_ADC are connected to SYS_VDD_1P8V and DGND, respectively, through ferrite beads inside the SiP. It is not necessary to connect these rails to anything else. However, bypass capacitors should be added to reduce noise, if needed for your application.

Maximum voltage for the analog inputs is 1.8V.

AIN7 currently monitors the PMIC voltages via the internal PMIC mux. See the 'Analog Multiplexer' section of the TPS65217 datasheet. For the internal PMIC voltages, there are dividers within the PMIC to keep the monitored voltages under 1.8V. However, PMIC_MUX_IN does not have any dividers and must be less than 1.8V. By default, PMIC_MUX_OUT is Hi-Z. The MUXCTRL register in the PMIC is used to select the PMIC_MUX_OUT voltage path.

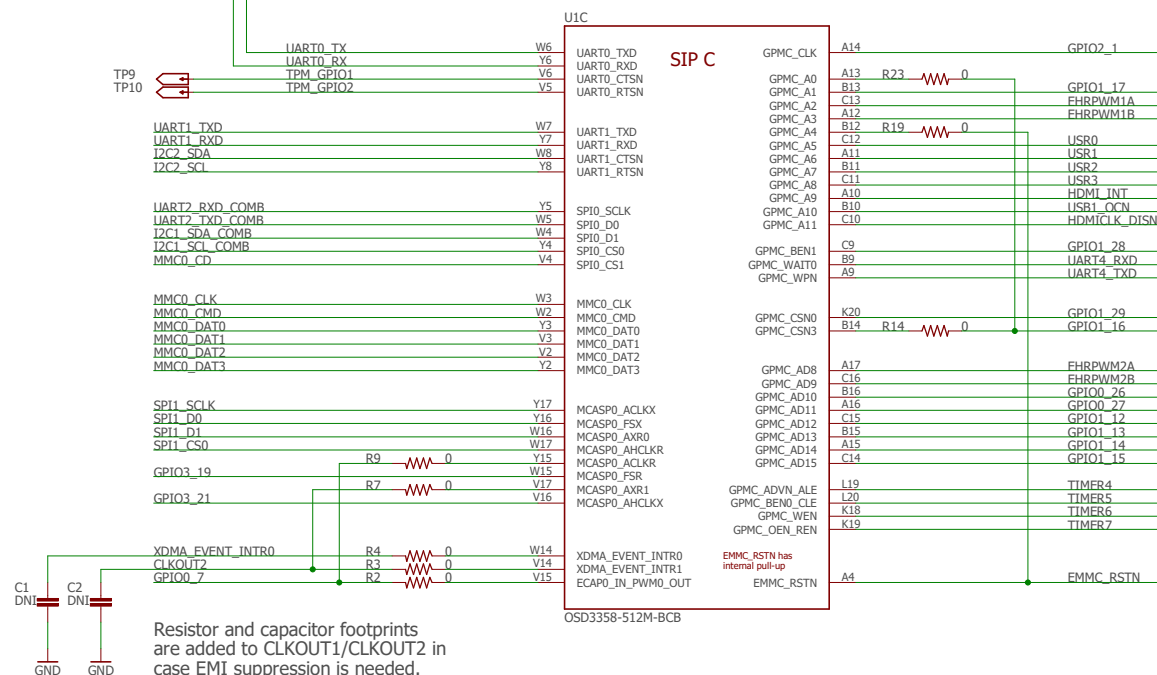
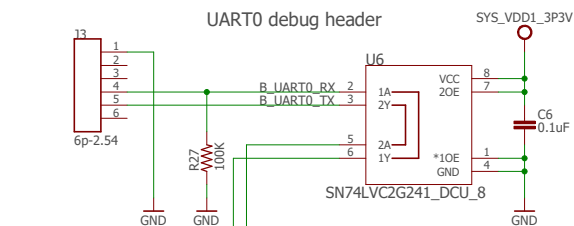
SYS_VDD1_3P3V is a 3.3V output of the OSD3358-512M-BSM. A divide by 2 resistor divider is used to ensure that the PMIC_MUX_IN voltage does not exceed 1.8V. It is not necessary to monitor the TL5209 LDO output and this can be removed if desired.

RTC_KALDO_ENN is grounded thru a 10K ohm resistor so that the internal RTC LDO is enabled and CAP_VDD_RTC does not need to be connected to VDD_CORE.



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Microcontroller Pin	Module Pin	Module Pin Name
MI11_TXCLK	T18	LCD_DATA0
MI11_TXD0	T19	LCD_DATA1
MI11_TXD1	R19	LCD_DATA2
MI11_TXD2	R18	LCD_DATA3
MI11_TXD3	P18	LCD_DATA4
MI11_TXFN	R20	LCD_DATA5
MI11_CRS	P18	LCD_DATA6
MI11_COL	P19	LCD_DATA7
	P20	LCD_DATA8
	N18	LCD_DATA9
	N19	LCD_DATA10
	N20	LCD_DATA11
	M18	LCD_DATA12
	M19	LCD_DATA13
	M20	LCD_DATA14
	L18	LCD_DATA15
FLASH_EN	U18	LCD_PCLK
MDIO_CLK	R31	LCD_VSYNCK
MDIO_DATA	R30	LCD_VSYNCK
	U19	LCD_HSYNCK
	R29	LCD_HSYNCK
	V20	LCD_AC_BIAS_EN
	R28	LCD_AC_BIAS_EN



Resistor and capacitor footprints are added to CLKOUT1/CLKOUT2 in case EMI suppression is needed.

Nets like CLKOUT2, GPIO0_7 and GPIO1_16 are resistor muxed to increase the functionality of the Cape Headers. This is not needed if your application does not require Cape Header compatibility.



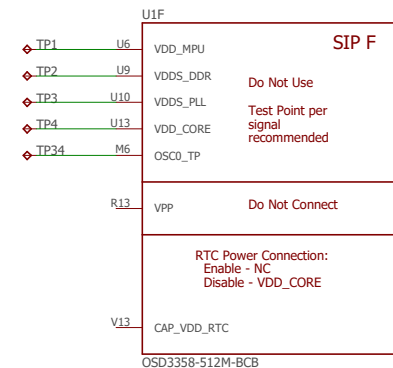
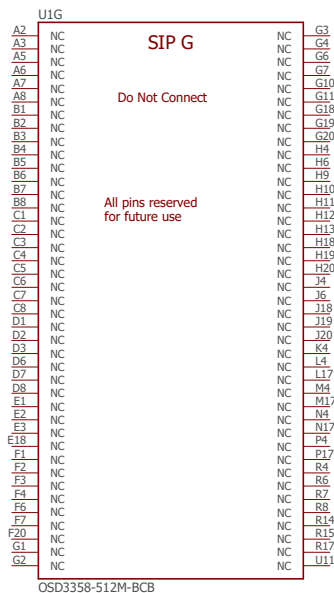
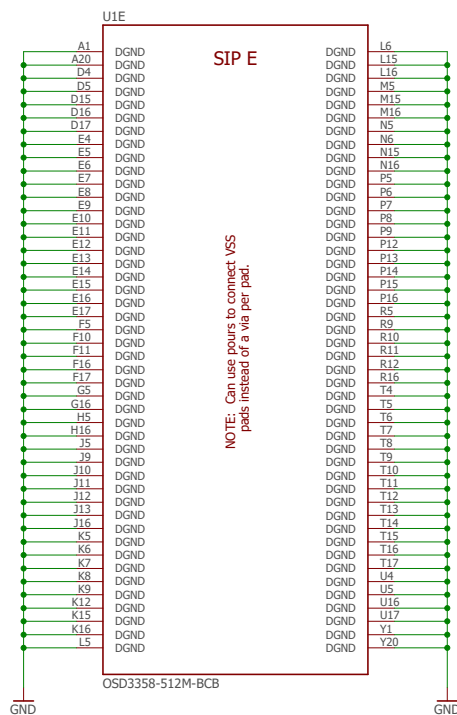
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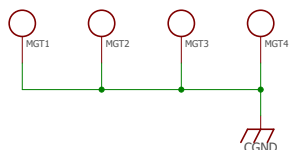
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SiP GND & Misc



Mounting Holes



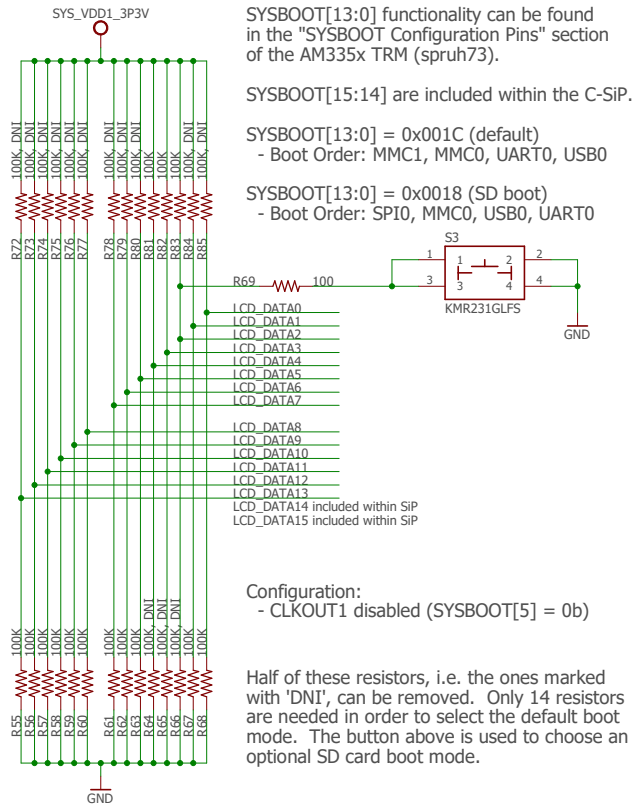
Mounting holes and other connector shields are part of a ground ring, CGND. This ring is connected to ground via a resistor on Page 1.

Fiducials

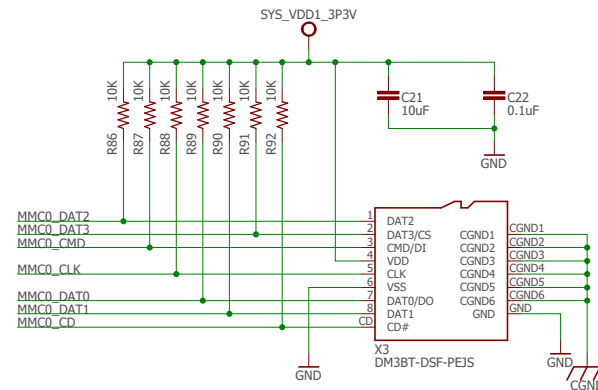


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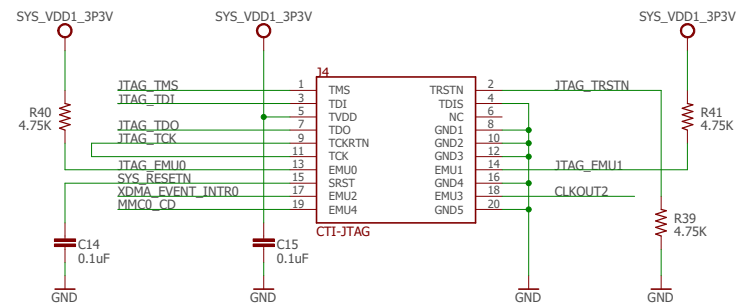
Boot configuration



Micro SD card slot



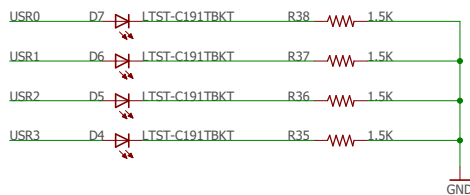
JTAG Header



Only connect EMU2, EMU3 and EMU4 if you plan to use advanced JTAG features (HS-RTDX, Core Trace, System Trace, etc) of higher end debuggers:

- http://processors.wiki.ti.com/index.php/JTAG_Connectors
- http://processors.wiki.ti.com/index.php/XDS_Target_Connection_Guide

User LEDs

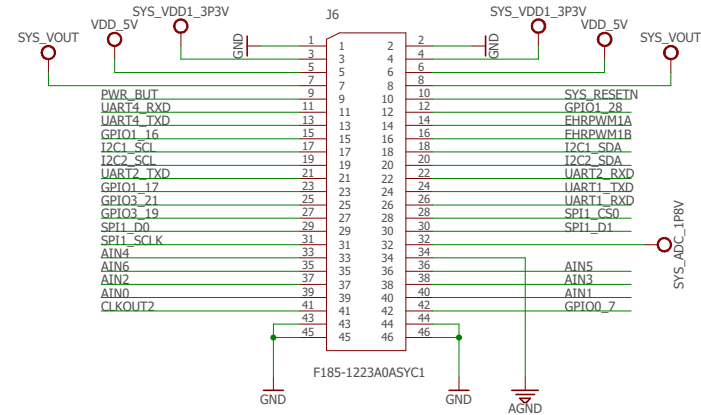
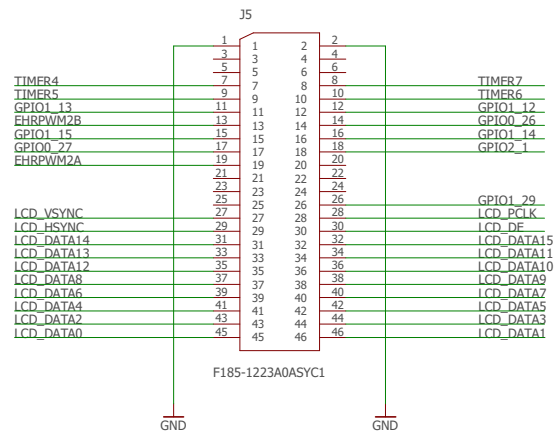


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Cape Headers

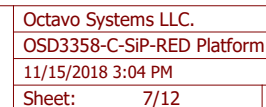
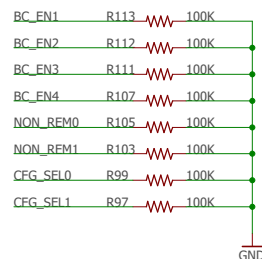
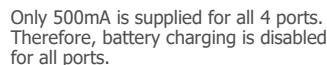


The Cape Headers are not fully compatible with all capes. The eMMC has been incorporated within the OSD3358-512M-BCB. Therefore, the 10 eMMC signals that are part of cape headers are no longer present. The signals not present are: GPMC_CSN1, GPMC_CSN2, and GPMC_AD[0:7]

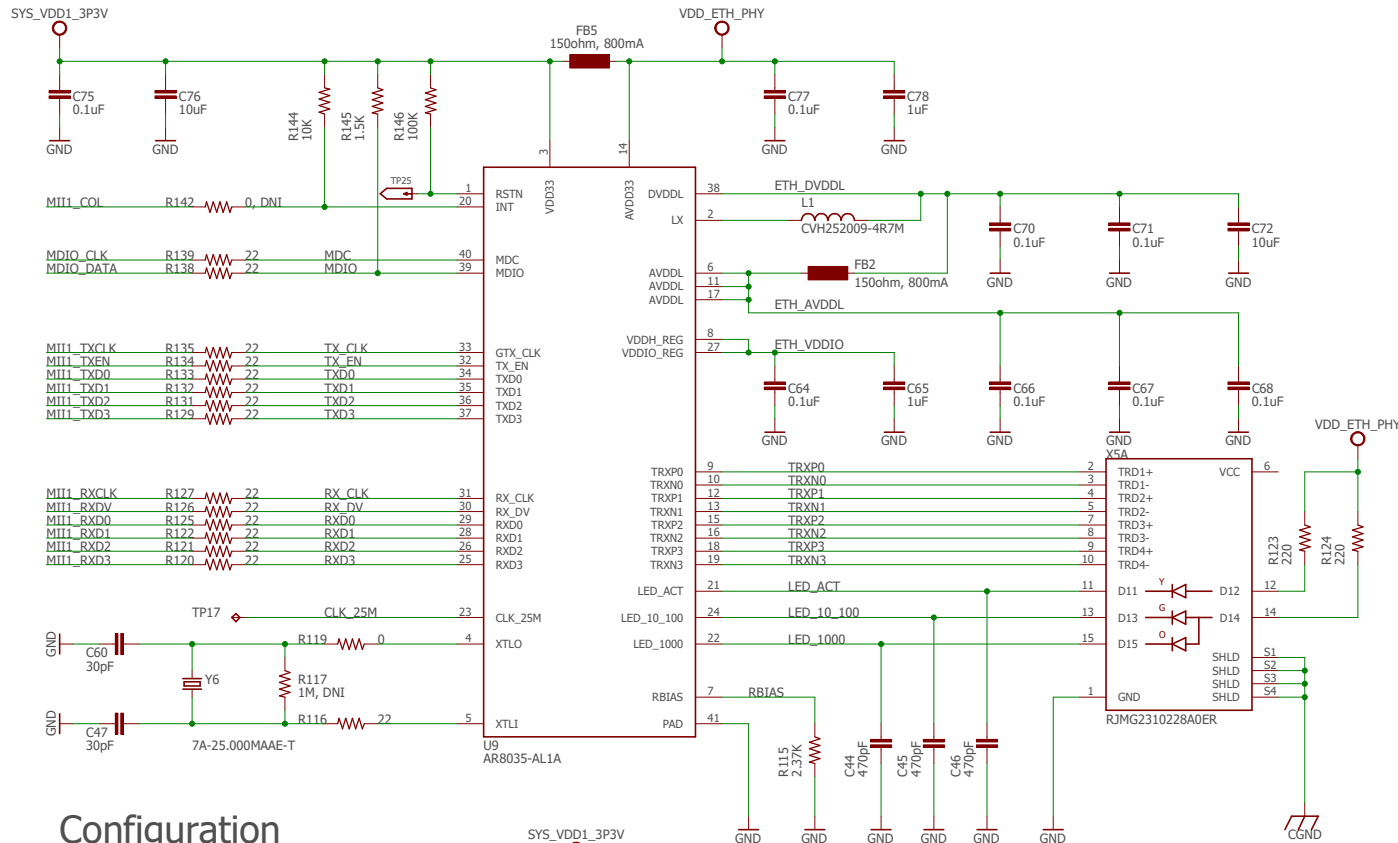


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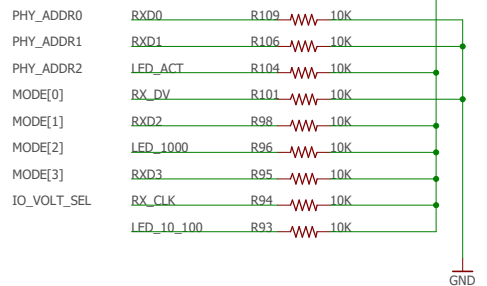
E



Ethernet



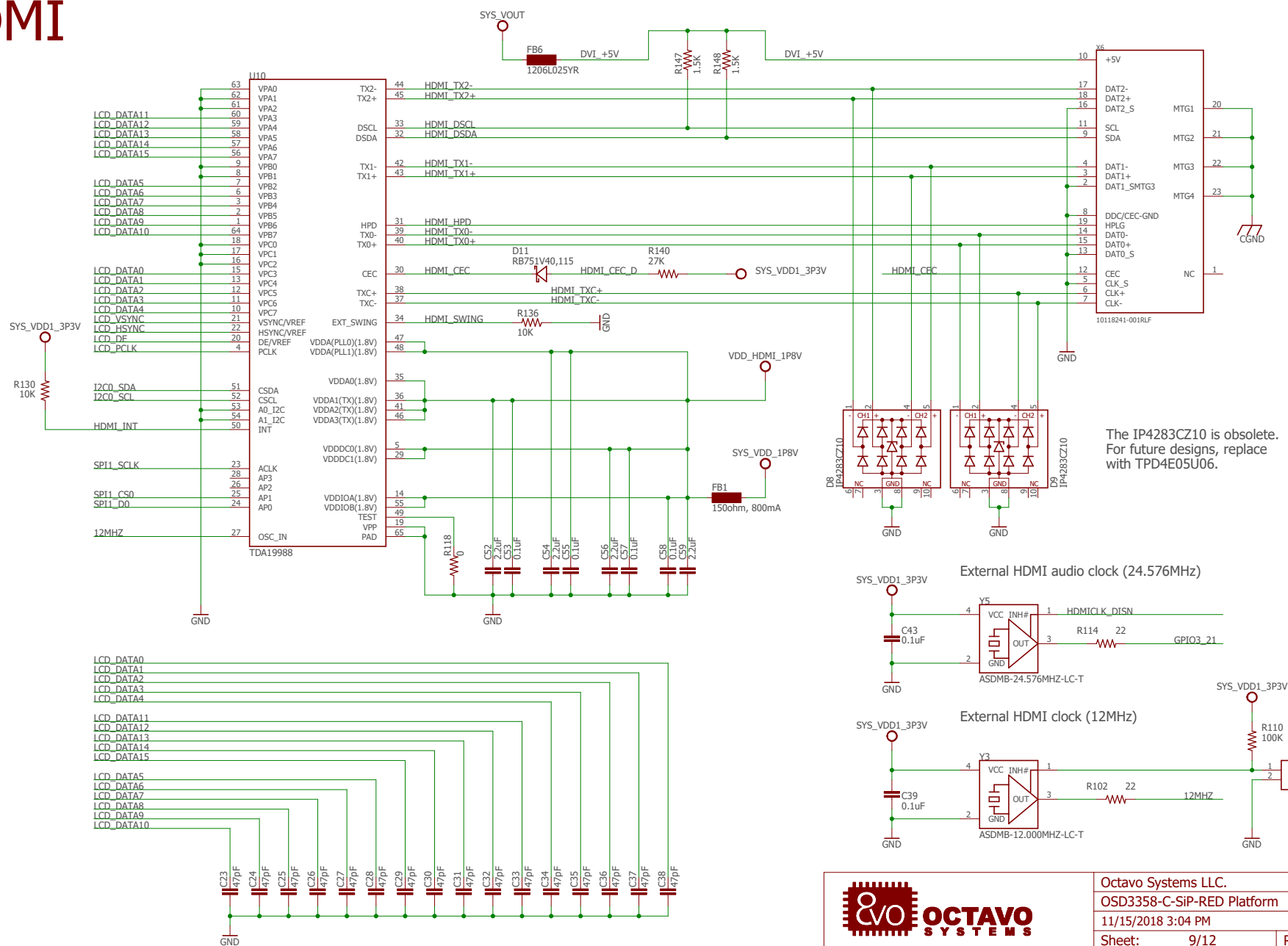
Configuration



Ethernet Connector:
VCC pin is exposed but should be left floating
for proper connector operation.



HDMI



A



A



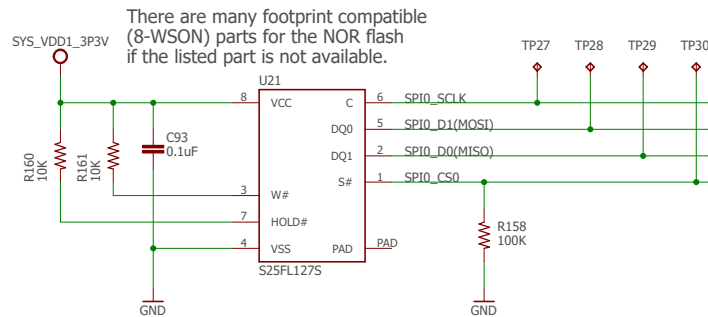
C



E



Secure NOR Boot Flash

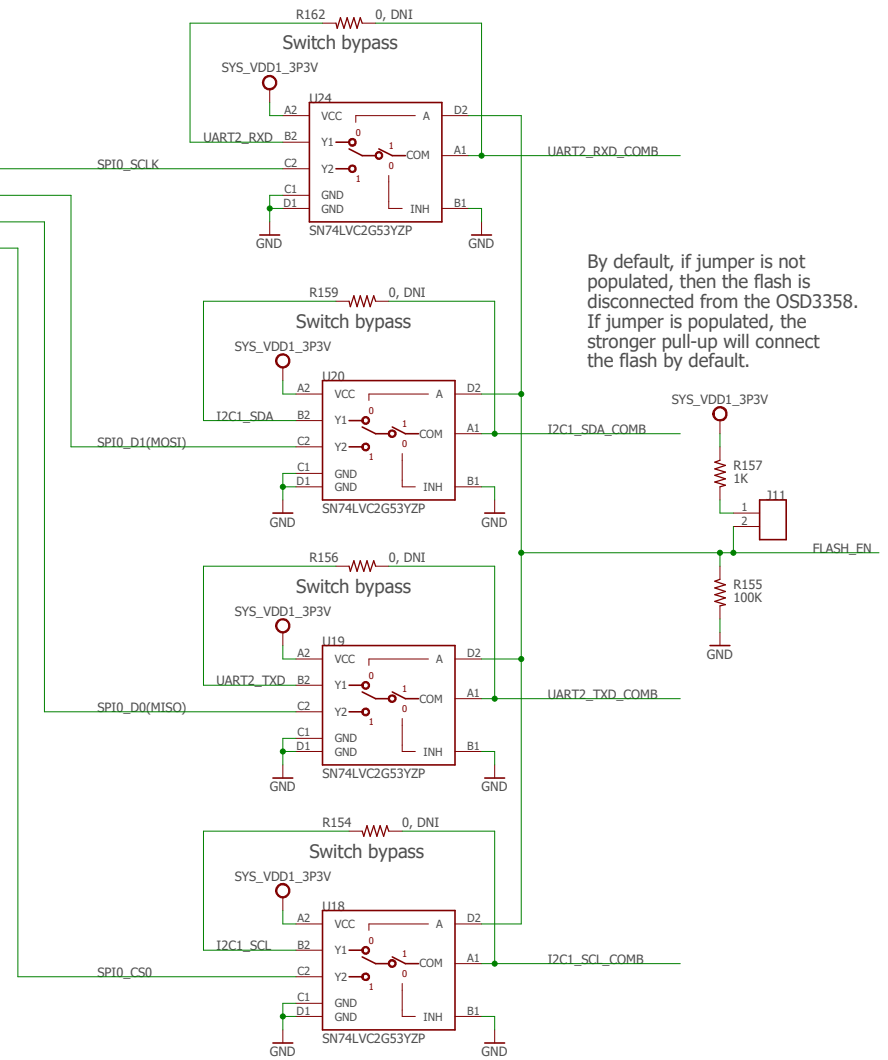
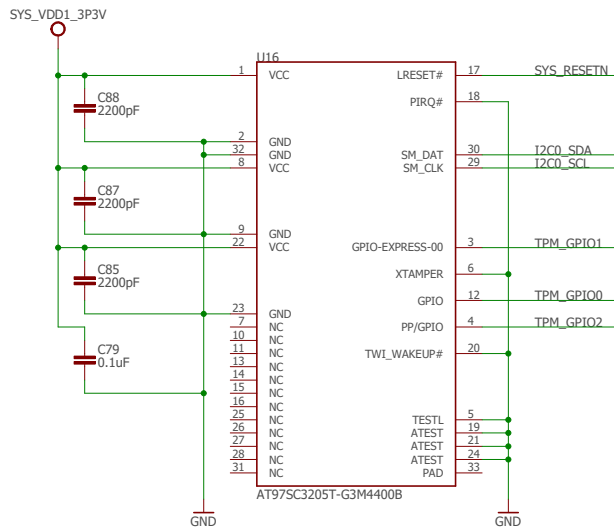


To be pin compatible with the Cape headers, we need to be able to connect or disconnect the flash memory from the OSD335x-SM. This circuit accomplishes that. When pin S# on the flash is low, the flash will ignore all other inputs. Therefore, there is a 100K pull-down on SPI0_CS0 that will pull that pin low when the flash is disconnected. Given that I2C1 pins might have pull-up resistors on a cape or the UART2 pins could be connected, we need to use 2:1 analog switches to connect or disconnect the flash.

Population Options:

- 1) If using the flash, all switches should be populated.
- 2) If not using the flash, the switch bypass resistors can be populated to maintain cape compatibility.

TPM



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Notes

Rev 1:
1) Initial release for OSD3358-512M-BCB. Updated from OSD3358-SM-RED. Schematics and Layout only; Board has not been manufactured.



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